Attorney Docket No.: SAM-0291

Declaration, Petition and Power of Attorney for Patent Application

As a below named inventor, I hereby declare that:

My residence, mailing address, and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

TAPE CARRIER PACKAGE (TCP) ON WHICH SEMICONDUCTOR CHIPS ARE MOUNTED AND METHOD OF MANUFACTURING THE SAME

the specification	of which (check only	one):		
<u>X</u>	is attached hereto; or			
		tates or PCT International Applicable).	plication Serial No.	, on,
	at I have reviewed and ent referred to herein.	understand the contents of the	specification, including the	claims as amended
with Title 37 C.: available between	F.R. §1.56, including for	ormation which is material to the continuation-in-part application and the nation	tions, material information	which became
for patent or invother than the U	entor's certificate or §: nited States of America or's certificate or any Po America filed by me o	under 35 U.S.C. §119(a)-(d) 365(a) of any PCT international a listed below and have also id CT international application(s) in the same subject matter having	al application(s) designating entified below any foreign a designating at least one co	g at least one country application(s) for untry other than the
Pr	ior foreign/PCT applic	ation(s) and priority claims un	der 35 U.S.C. §119(a)-(d) o	or §365
	Country	Application Number	Filing Date (day, month, year)	
	Korea	01-27326	18 May 2001	
I hereby claim t		S.C. §119(e) of any United Sta		s) listed below.

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I hereby claim the benefit under 35 U.S.C.§ 120 of any United States application(s) or PCT international application(s) designating the United States of America that is/are listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose material information as defined in 37 C.F.R. §1.56 which occurred between the filing date of the prior applications and the national or PCT international filing date of this application:

Prior U.S. Applications or PCT International Applications designating the U.S. for benefit under 35 U.S.C. § 120

Application Number	Filing Date (day, month, year)	Status (issued, pending, abandoned)

As a named inventor, I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Steven M. Mills Reg. No. 36,610

Anthony P. Onello, Jr.

Reg. No. 38,572

Send correspondence and direct telephone calls to:

Steven M. Mills MILLS & ONELLO LLP Eleven Beacon Street, Suite 605 Boston, Massachusetts 02108 phone: (617) 994-4900 facsimile: (617) 742-7774

Wherefore I petition that letters patent be granted to me for the invention or discovery described and claimed in the attached specification and claims, and hereby subscribe my name to said specification and claims and to the foregoing declaration, power of attorney, and this petition.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

First Inventor

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